onsemi

EcoSPARK[®] 2 HV-HE IGBT 500 mJ, 650 V, N-Channel PTC Heater IGBT FGB5065G2-F085

Features

- SCIS Energy = 500 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- RoHS Compliant
- Pending AEC-Q101 Qualification and PPAP Capable

Applications

- PTC Heater Circuits
- High Current Systems
- Rugged Applications

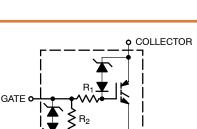
MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
BV _{CER}	Collector-to-Emitter Breakdown Voltage $(I_{C} = 1 \text{ mA})$	650	V
BV _{ECS}	Emitter-to-Collector Voltage – Reverse Battery Condition (I _C = 10 mA)	28	V
E _{SCIS25}	Self Clamping Inductive Switching Energy (Note 1)	500	mJ
E _{SCIS150}	Self Clamping Inductive Switching Energy (Note 2)	300	mJ
I _{C25}	Collector Current Continuous at V_{GE} = 5.0 V, T_C = 25°C	78	A
I _{C100}	Collector Current Continuous at V_{GE} = 5.0 V, T_{C} = 100°C	55	A
V _{GEM}	Gate-to-Emitter Voltage Continuous	±10	V
PD	Power Dissipation Total, $T_C = 25^{\circ}C$	300	W
	Power Dissipation Derating, $T_C > 25^{\circ}C$	2	W/°C
T _J , T _{STG}	Operating Junction and Storage Temperature Range	–55 to +175	°C
ΤL	Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	300	°C
T _{PKG}	Reflow Soldering according to JESD020C	260	°C
ESD	HBM-Electrostatic Discharge Voltage at 100 pF, 1500 Ω	8	kV
	CDM-Electrostatic Discharge Voltage at 1 Ω	2	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

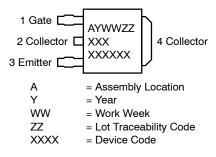
- 1. Self clamped inductive Switching Energy (E_{SCIS25}) of 500 mJ is based on the test conditions that is starting $T_J = 25^{\circ}$ C, L = 3 mHy, $I_{SCIS} = 18.3$ A, $V_{CC} = 100$ V during inductor charging and VCC = 0 V during time in clamp.
- 2. Self Clamped inductive Switching Energy ($E_{SCIS150}$) of 300 mJ is based on the test conditions that is starting $T_J = 150^{\circ}$ C, L = 3 mHy, $I_{SCIS} = 14.2$ A, $V_{CC} = 100$ V during inductor charging and $V_{CC} = 0$ V during time in clamp.





MARKING DIAGRAM

EMITTER



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

Characteristic	Symbol	Max	Units
Junction-to-Case - Steady State (Drain)	$R_{ ext{ heta}JC}$	0.5	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
OFF CHARA	ACTERISTICS	-					-
BV _{CER}	Collector-to-Emitter Breakdown Voltage	I_{CE} = 2 mA, V_{GE} = 0 V, R _{GE} = 1 kΩ, T _J = -40 to 150°C		615	650	685	V
BV _{CES}	Collector-to-Emitter Breakdown Voltage	I_{CE} = 10 mA, V_{GE} = 0 V, R _{GE} = 0, T _J = -40 to 150°C		635	680	710	V
BV_{ECS}	Emitter-to-Collector Breakdown Voltage	I_{CE} = -75 mA, V_{GE} = 0 V, T _J = 25°C		28	-	_	V
BV_{GES}	Gate-to-Emitter Breakdown Voltage	I _{GES} = ±2 mA		±12	±14	-	V
I _{CER}	Collector-to-Emitter Leakage Current	V _{CE} = 250 V R _{GE} = 1 kΩ	$T_J = 25^{\circ}C$	-	-	25	μA
			T _J = 150°C	-	-	1	mA
I _{ECS}	Emitter-to-Collector Leakage Current	V _{EC} = 24 V	$T_J = 25^{\circ}C$	-	-	1	mA
			T _J = 150°C	-	-	40	
R ₁	Series Gate Resistance	<u> </u>		-	115	_	Ω
R ₂	Gate-to-Emitter Resistance			10K	-	30K	Ω
N CHARA	CTERISTICS	-		-			-
V _{CE(SAT)}	Collector-to-Emitter Saturation	I _{CE} = 10 A, V _{GE}	= 4.5 V, T _J = 25°C	_	1.12	1.33	V
	Voltage	ge I _{CE} = 30 A, V _{GE} = 5 V, T _J =	= 5 V, T _J = 25°C	_	1.56	1.80	1
		I_{CE} = 50 A, V_{GE} = 10 V, T_{J} = 25°C		-	1.80	2.15	
		I_{CE} = 15 A, V_{GE} = 5 V, T_{J} = 150°C		_	1.26	_	
YNAMIC C	HARACTERISTICS						
Q _{G(ON)}	Gate Charge	I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V		_	40	_	nC
V _{GE(TH)}	Gate-to-Emitter Threshold Voltage	I _{CE} = 1 mA V _{CE} = V _{GE}	$T_J = 25^{\circ}C$	1.3	-	2.2	V
			T _J = 150°C	0.75	-	1.8	
V _{GEP}	Gate-to-Emitter Plateau Voltage	V _{CE} = 12 V, I _{CE} = 10 A		-	2.7	-	V
WITCHING	CHARACTERISTICS						
td _{(ON)R}	Current Turn-On Delay Time-Resistive	$ \begin{array}{l} {\sf V}_{CE} = {\rm 14}\;{\sf V},\;{\sf R}_L = {\rm 1}\;\Omega,\\ {\sf V}_{GE} = {\rm 5}\;{\sf V},\;{\sf R}_G = {\rm 470}\;\Omega,\\ {\sf T}_J = {\rm 25^\circ C} \end{array} $		-	0.77	3	μs
t _{rR}	Current Rise Time-Resistive			-	1.5	7	1
td _{(OFF)L}	Current Turn-Off Delay Time-Inductive	$ \begin{array}{l} V_{CE} = 300 \text{ V}, \text{ L} = 1 \text{ mH}, \\ V_{GE} = 5 \text{ V}, \text{ R}_{G} = 470 \ \Omega, \\ I_{CE} = 6.5 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C} \end{array} $		-	6.7	12	1
	Current Fall Time-Inductive			_	3.4	15	1

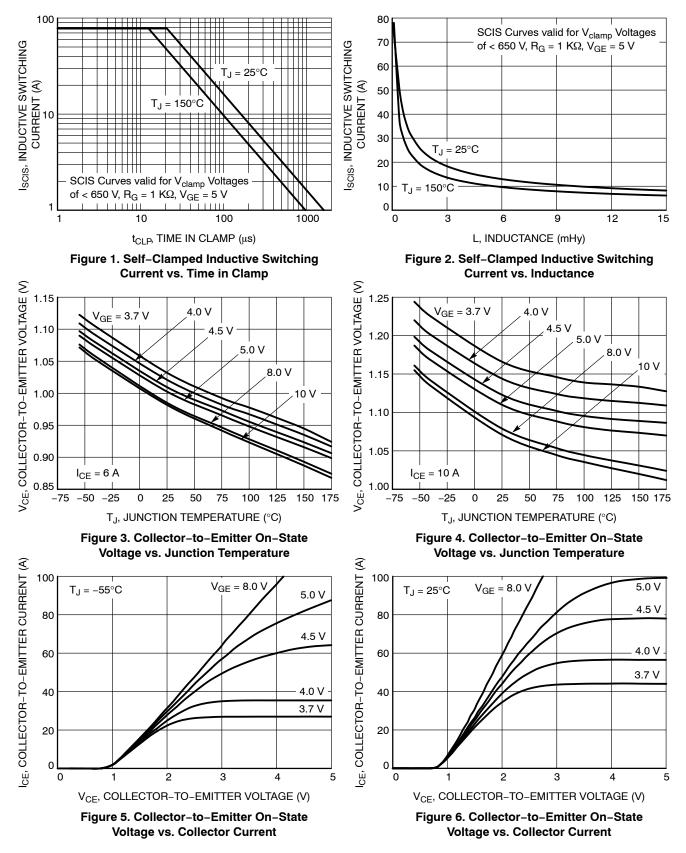
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

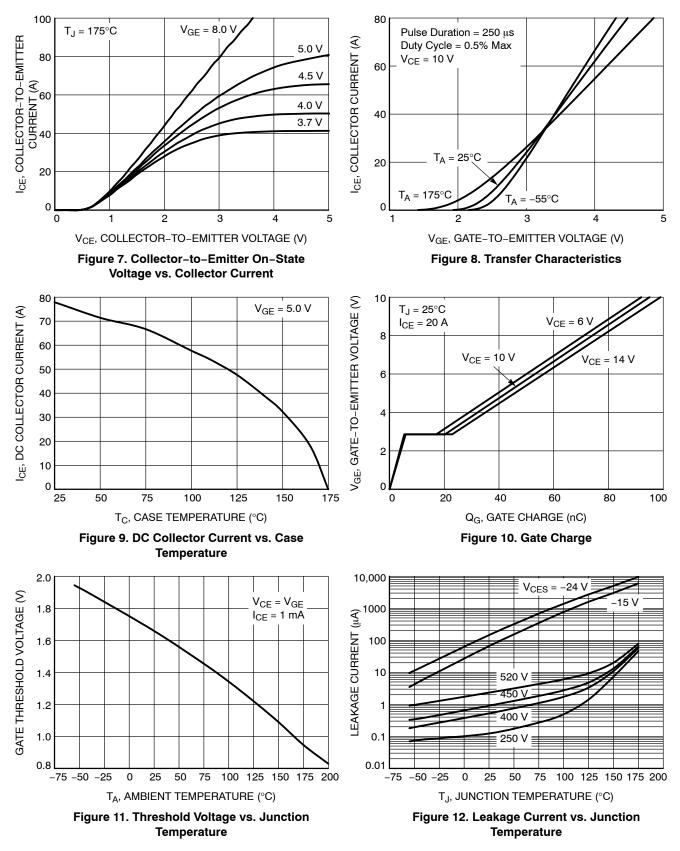
Device	Package	Shipping [†]
FGB5065G2-F085	D ² PAK (Pb-Free)	800 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS



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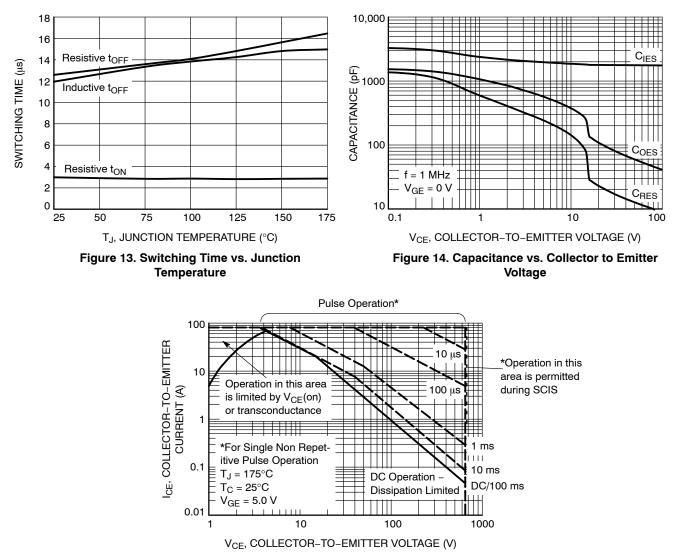
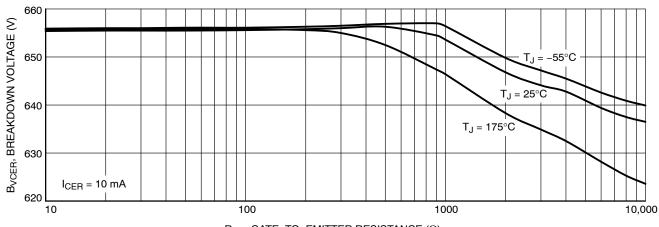


Figure 15. Forward Bias Safe Operating Area

TYPICAL CHARACTERISTICS



 R_{GE} , GATE-TO-EMITTER RESISTANCE (Ω)



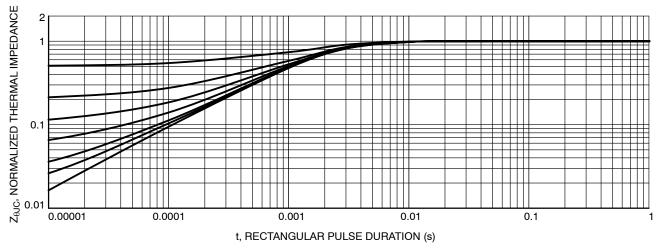
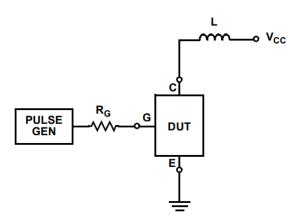


Figure 17. Normalized Transient Thermal Impedance, Junction to Case ($Z_{\theta JC}$)

TEST CIRCUIT AND WAVEFORMS



 $R_{G} = 1K\Omega$ G E V_{CC}

Figure 18. Inductive Switching Test Circuit

Figure 19. t_{ON} and t_{OFF} Switching Test Circuit

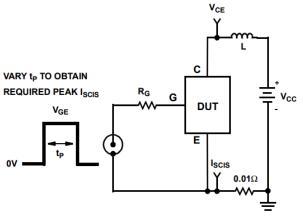


Figure 20. Energy Test Circuit

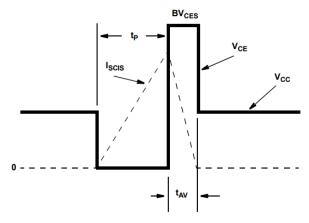


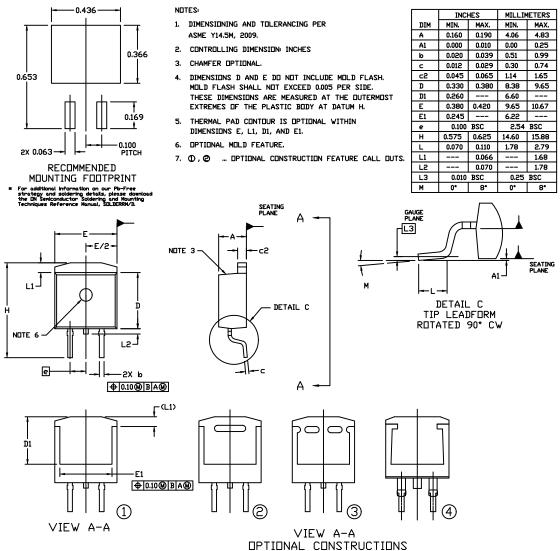
Figure 21. Energy Waveforms

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PACKAGE DIMENSIONS

D²PAK-3 (TO-263, 3-LEAD) CASE 418AJ

ISSUE F



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